<b>T</b> HANSE	HC-590T1608D-E	Spec. No.	HP-M629
Hanse Electronics Corp.	TOP VIEW YELLOW LED	Part	LED

# SPECIFICATION

CUSTOMER	:		

DEVICE NAME :

MODEL NO. :

ISSUED DATE :

## [CUSTOMER APPROVAL]

APPROVAL NO.				
APPROVAL DATE				
	INSPECTER	CHECK	APPROVAL	COMMENT
APPROVAL				

[ SUPPLIER ]

	ISSUE	REVIEW	REVIEW	APPR'D
ISSUED DEPT.				

<b>T</b> HANSE	HC-590T1608D-E	Spec. No.	HP-M629
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- 1. FEATURES
- 2. OUTLINE DIMENSIONS
- 3. SPECIFICATIONS
- 4. COMPOSITION OF DEVICE
- 5. ELECTRO-OPTICAL CHARACTERISTICS CURVES
- 6. SELECTION GUIDE : CLASSIFICATION BY NAME
- 7. RELIABILITY
- 8. TAPING
- 9. PACKING
- 10. CAUTIONS
- 11. RANKS
- 12. REVISION HISTORY SHEET



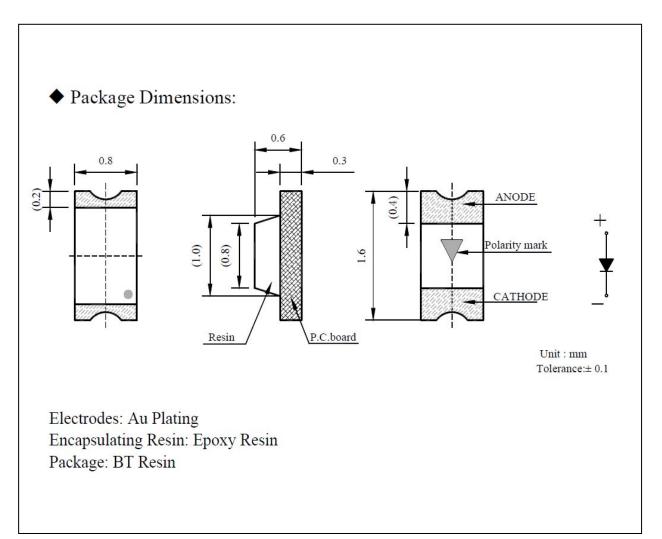
<b>T</b> HANSE	HC-590T1608D-E	Spec. No.	HP-M629
Hanse Electronics Corp.	TOP VIEW YELLOW LED	Part	LED

## **1. FEATURES**

- SMD Top View type
- Chip technology : GaAIInP
- High luminous Intensity
- Viewing angle : Lambertian emitter(120°)
- Package size : 1.6  $\,\times\,$  0.8  $\,\times\,$  0.6
- Reliability test completion
- Suitable for all SMT



# 2. OUTLINE DIMENSIONS



<b>HANSE</b>	HC-590T1608D-E
Hanse Electronics Corp.	TOP VIEW YELLOW LED

Spec. No. HP-M629

LED

(Ta=25℃)

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Part

# **3. SPECIFICATIONS**

### Absolute Maximum Rating

			(Ta=25 €)
Parameter	Symbol	Value	Unit
Power Dissipation	P <sub>D</sub>	60	mW
Peak Forward Current <sup>1</sup>	I <sub>FP</sub>	80	mA
Reverse Voltage	V <sub>R</sub>	5	V
Forward Current	I <sub>F</sub>	20	mA
Operating Temperature	Topr	-25 to + 85	°C
Storage Temperature	Tstg	-30 to + 85	°C
Soldering temperature	Tsol	Reflow soldering : 240 $^{\rm C}$ , 5 sec Hand Soldering : 300 $^{\rm C}$ , 3 sec	

▶ 1 : Duty Ratio  $\leq$  1/10, Pulse Width  $\leq$  10 msec

## Electro-Optical Characteristics

						(Ta=25℃)
Parameter	Symbol	Condition	Min	Тур	Max	Unit
Forward Voltage	V <sub>F</sub>	I <sub>F</sub> =15 mA	1.9		2.2	V
Reverse Current	I <sub>R</sub>	V <sub>R</sub> =5V	-	-	10	μA
Luminous Intensity > 2	Iv	I <sub>F</sub> =15 mA	45		130	mcd
Viewing Angle <sup>&gt; 3</sup>	<b>2</b> ⊖ <sub>1/2</sub>	I <sub>F</sub> =15 mA	-	±60	-	deg.
Wavelength	λ	I <sub>F</sub> =15 mA	586		594	nm

▶ 2 : Luminous intensity is measured with a light sensor and CIE eye-response curve filter combination.

▶ 3 :  $\Theta_{1/2}$  is the off-axis angle at which the luminous intensity is half the peak intensity.

\* Measurement Uncertainty : ± 10%



LED

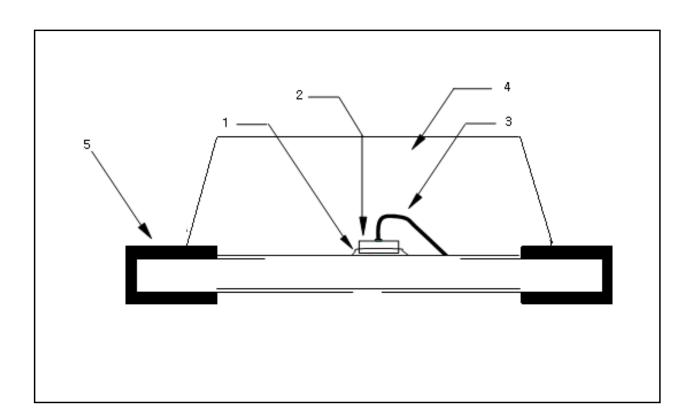
Part

# 4. COMPOSITION OF DEVICE

#### A. MATERIALS OF PACKAGE

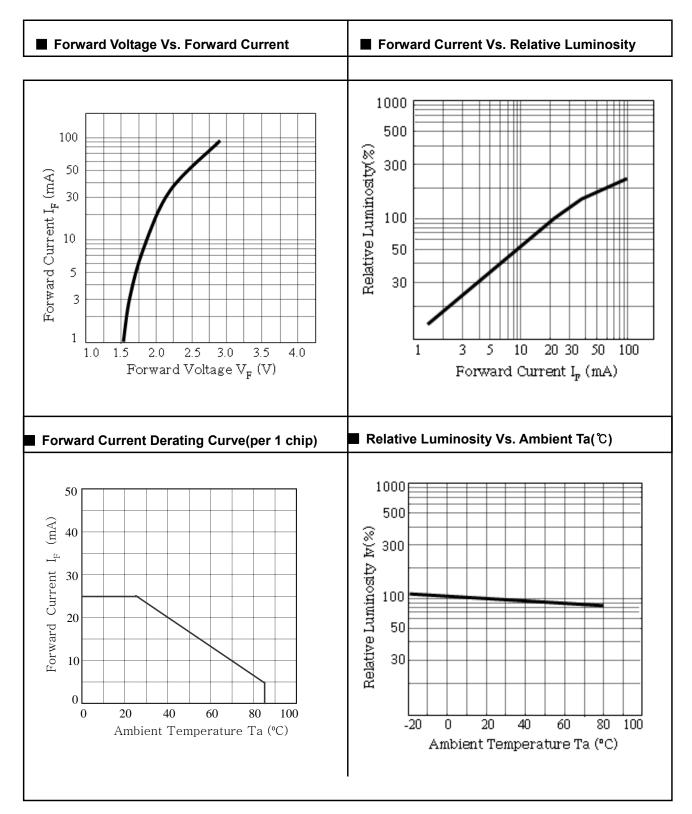
Number	Item	Material
1	Die adhesive	Ag Epoxy
2	LED Chip	GaAlInP
3	Au Wire	1.0mil
4	Mold epoxy	Epoxy Resin
5	Electrodes	Au Plating Cu Alloy

#### **B. DIAGRAM OF COMPOSITION**



# 5. ELECTRO-OPTICAL CHARACTERISTICS CURVES <sup>▶1</sup>

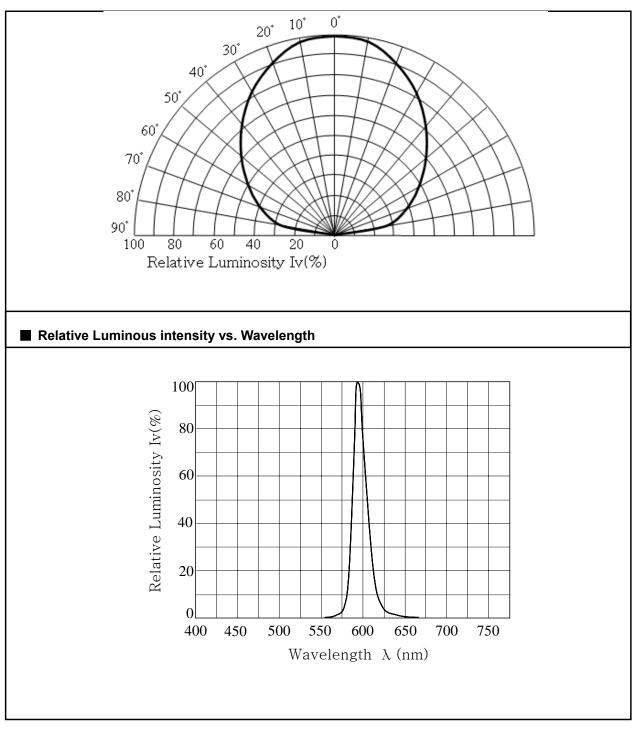
### $\blacktriangleright$ 1 : These graph are based on 1-die performance



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# 5. ELECTRO-OPTICAL CHARACTERISTICS CURVES

## Radiation Characteristics



# 6. SELECTION GUIDE : CLASSIFICATION BY NAME

HESP-AA-629

HANSE Hanse Electronics Corp.	HC-590T1608D-E	Spec. No.	HP-M629
	TOP VIEW YELLOW LED	Part	LED
		2011/05-	-REV : 2.0

LED CATEGORY   EMITTING COLOR (d	ominant wavelength)
	PACKAGE TYPE
• CH	IP LED : THICKNESS
	] - ( )
LEAD TYPE LED : ① Lens color ② shape ③ lv reference	
IV RANK	
VF RANK	•
COLOR RANK •	OPTION

LED CATEGORY		
C : Chip LED L : Le	ad type LED	
EMITTING COLOR (dominant	vavelength)	
460, 465, 470, 475, 480 : Blue	595, 600, 605 : Orange	RB1- : Red+Blue(Dual color)
500 : Cyan	610, 615, 620, 625 : Amber	RB3- : Red+Blue(Another color)
510, 515, 520, 565 : <b>P</b> ure Green	630, 640, 660( $\lambda_p$ ) : Red	RGB1- : R+G+B(Full color)
570, 575 : Yellow Green	W : White (WF : WHITE FOR FLASH)	RGB3- : R+G+B(Another color)
580, 585, 590 : Yellow	BW : Bluish White	RM : Red+Yellow Green
PACKAGE TYPE		
T1608 : Top View 1608	T3528 : Top View 3528	Round type : R2, R3, R4, R5,R8, R10
T1612 : Top View 16125	T5450 : Top View 5450	Flat type : F2, F3, F5
T1615 : Top View 1625	S2110 : SideView 2110 Type	Tow <mark>e</mark> r type : E2
T2012 : Top View 20125	S2812 : SideView 2812 Type	Oval type : O3, O4, O5
T3030 : Top View 3030	S4014 : SideView 4014 Type	Re <mark>c</mark> tangular type : C4, C5
T3216 : Top View 3216	S3215 : SideView 3215 Type	(Number = diameter)
T3530 : Top View 3530	S143 : SideView 143 Type	
Chip LED : THICKNESS : A : 0.3	T, B : 0.4T, C : 0.55T, D : 0.6T, E : 0.8T, F : 1.0	T, G : 2.0T, BLANK(Normal)
Lead Type LED :		
① Lens Color - 2 : Milky Diffusion	n(M/D) / <b>3</b> : Water Clear(W/C) / <b>4</b> : Color C	lear(C/C) / 5 : Colored Diffusion(C/D)
② Shape – 11 / 12 / 13 / 14 / 15/	etc : please refer to package dimension s	heet
③ Iv reference : -H(High) / -V(Ve	ry) / -U(Ultra) / -SU(Super ultra)	
IV RANK, VF RANK, COLOR R	ANK - Pofor to rank shoot	
IN RAINE, NE RAINE, COLOR R		

**OPTION : OPTIONAL** 



Spec. No. HP-M629

LED

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Part

## 7. RELIABILITY

#### A. TEST ITEMS AND RESULTS

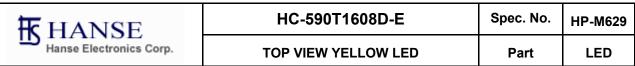
Test Item	Standard test method	Test Conditions	Note	Number of Damaged
Resistance to Soldering Heat (Reflow Soldering)	JEITA ED-4701 300 301	Tsol=240 ℃, 10sec. (Pre treatment 30 ℃, 70%, 168hrs.)	2 times	0/50
Solderability (Reflow Soldering)	JEITA ED-4701 100 105	Tsol=215±5℃, 3sec.	1 time over 95%	0/50
Heat Shock	JEITA ED-4701 100 105	0℃~100℃ 5sec. 15sec.	20 cycles	0/50
Temperature Cycle	JEITA ED-4701 100 105	-40℃ ~ 25℃ ~ 100℃ ~ 25℃ 15min. 5min. 15min. 5min.	100 cycles	0/50
High Humidity Heat Cycle	JEITA ED-4701 200 203	30℃~65℃~-10℃ 90%RH 24hrs./1cycle	10 cycles	0/50
High Temperature Storage	JEITA ED-4701 200 203	Ta=100 ℃	1000 hrs.	0/50
Humidity Heat Load	JEITA ED-4701 100 103	Ta=60℃, RH=90%	1000 hrs.	0/50
Low Temperature Storage	JEITA ED-4701 200 202	Ta=-40 ℃	1000 hrs.	0/50
Life Test Condition 1		Ta=25℃, IF=80mA	1000 hrs.	0/50
High Temperature Life Test		Ta=85℃, IF=20mA	1000 hrs.	0/50
High Humidity Heat Life Test		60℃, RH=90%, IF=60mA	500 hrs.	0/50
Low Temperature Life Test		Ta=-30 ୯, IF=80mA	1000 hrs.	0/50

#### B. CRITERIA FOR JUDGING THE DAMAGE

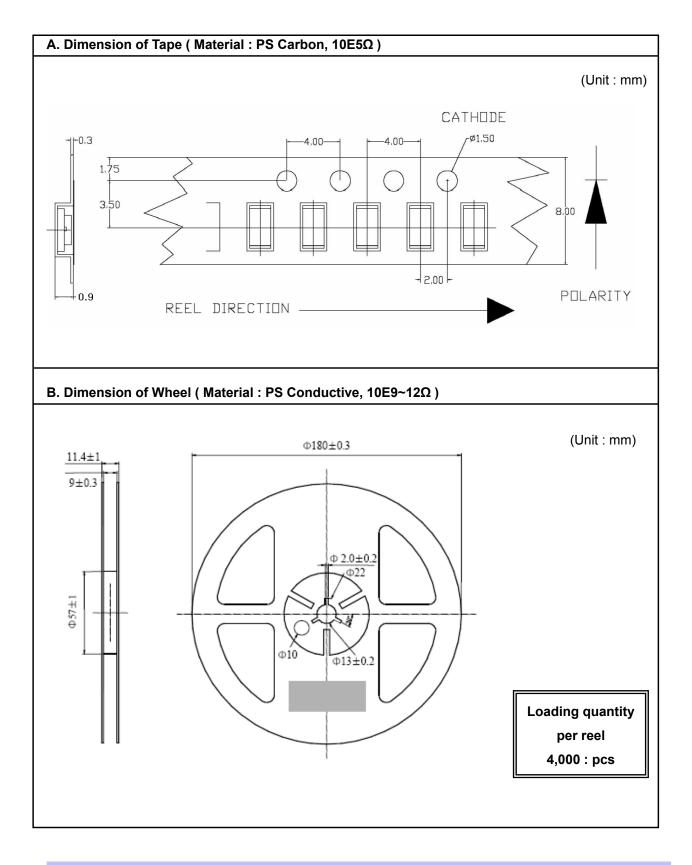
Item	Symbol	Test Conditions	Criteria fo	r Judgement
nem	Symbol	Test Conditions	Min.	Max.
Forward Voltage	VF	IF=80mA	-	U.S.L.*) × 1.1
Reverse Current	IR	VR=5V	-	U.S.L.*) × 2.0
Luminous Intensity	IV	IF=80mA	L.S.L.**) × 0.7	-

\*) U.S.L. : Upper Standard Level

\*\*) L.S.L. : Lower Standard Level

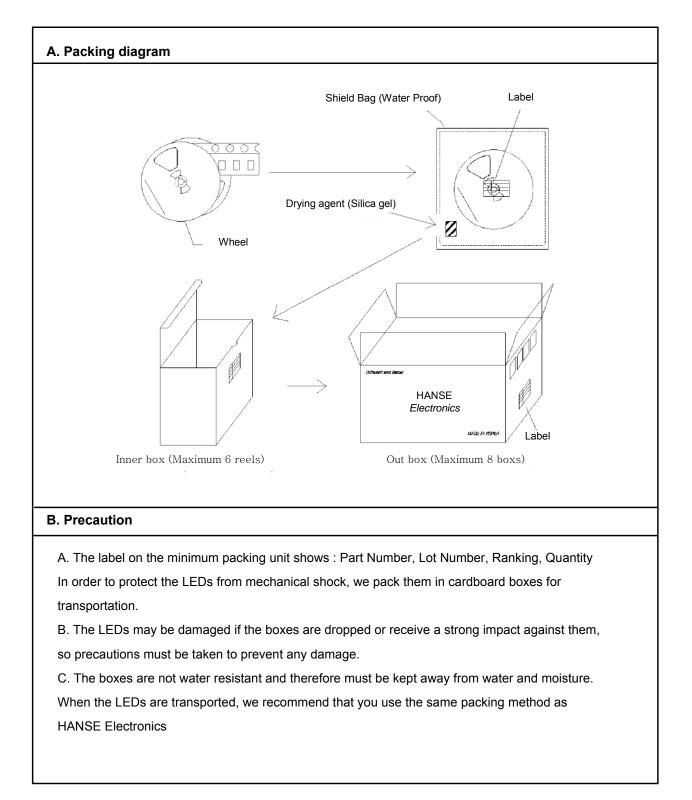


# 8. TAPING



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## 9. PACKING



LED

Part

# **10. CAUTIONS**

High Power White LEDs are devices which are materialized by combining Blue LEDs and special phosphors. Consequently, the color of White LEDs is changed a little by an operating current.

Care should be taken after due consideration when using LEDs

(1) Moisture Proof Package

- When moisture is absorbed into the LEDs it may vaporize and expand during soldering. There is a
  possibility that this can cause the exfoliation of the contacts and the damage the optical
  characteristics of the LEDs. For this reason, the moisture proof package is used to keep moisture
  to a minimum in the package.
- After opening the package, the LEDs should be kept at 30℃, 40~70%RH. The LEDs should be soldered within 168 hours(7days) after opening the package.
- When storing the LEDs after opening the package, use a sealable away from package with a moisture absorbent material(Silica gel) inside.
- If the blue color of the desiccant indicator has faded after storing, a baking treatment should be performed as follows : 65 ± 5 ℃ for more than 24 hours.

## (2) Soldering Conditions

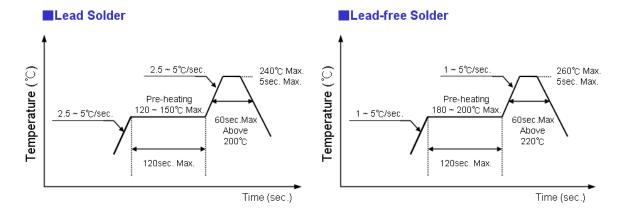
- The LEDs can be soldered in place using the reflow soldering method.
- The recommended soldering conditions are as follows:

Reflow Soldering			Hand Se	oldering
	Lead Solder	Lead-free Solder		
Pre-heat	<b>120~150</b> ℃	<b>180~200</b> ℃	Temperature	300℃ Max
Pre-heat time	120sec Max	120sec Max	Soldering time	3sec Max
Peak temperature	240℃ Max	260℃ Max		(one time only)
Soldering time	5 sec Max	5 sec Max		
Condition	refer to	refer to		
	Temperature	Temperature		
	profile ①	profile (2)		

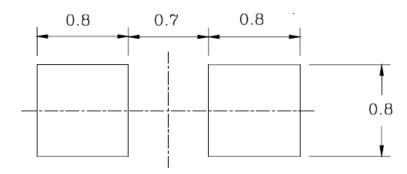
\* After reflow soldering rapid cooling should be avoided.

IN II UDL	<b>F</b> HANSE	HP-M629
Hanse Electronics Corp. TOP VIEW YELLOW LED Part	Hanse Electronics Corp.	LED

#### • Temperature-Profile



#### Recommended Soldering



(Unit : mm)

 Modifications should not be done after the LEDs have been soldered.
 If modifications cannot be avoided, a double-head soldering iron should be used after checking whether the characteristics of the LEDs will not be damaged by modification after soldering.

#### (3) Heat Generation

 Heat generation must be taken into design consideration when using the LEDs. The coefficient of temperature increase per input electric power is about 0.62 °C/mW at the LED's active layer. This coefficient will be affected by the heat resistance of the circuit board and by dense mounting of the LEDs. At the same time, precautions must be taken into the design of circuitry to avoid intense heat generation. Proper designs which allow radiation of heat, etc. may be needed.

#### (4) Static Electricity

- Static Electricity and surge damages the LEDs. It is recommended to use a wrist band or antielectrostatic glove when handling the LEDs.
- All devices, equipment and machinery must be properly grounded.
- When inspecting own final products on which LEDs were mounted, it is recommended to check also whether the mounted LEDs are damaged by static electricity or not.
- Damaged LEDs will show some unusual characteristics such as leak current remarkably increases, starting forward voltage becomes lower, or the LEDs get unlighted at the low current.

#### (5) Cleaning

 Use Isopropyl Alcohol as a solvent for cleaning the LEDs. Using other solvents may dissolve the LED package and the epoxy. Caution is needed.
 Ultrasonic cleaning of the LEDs should not be done.

#### (6) Others

- The electrode sections are plated with silver. Those will become discolored by contact with corroded gas etc. Precautions must be taken to maintain a clean storing atmosphere.
- These LEDs described in this brochure are intended to be used for ordinary electronic equipment. Consult HANSE's sales staff in advance for information on the applications in which exceptional quality and reliability are required, particularly when the failure or malfunction of the LEDs may directly jeopardize life or health (such as airplanes, aerospace, automobiles, life support systems and safety devices).
- User shall not reverse engineer by disassembling or analysis of the LEDs without having the prior written consent of HANSE. When defective LEDs are found, User shall inform to HANSE directly before disassembling or analysis.
- The appearance and specifications of the product may be modified for improvement without notice.

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## 11. RANKS

# Luminous Intensity(I<sub>v</sub>) Ranks

					(Ta=25℃)
lv Rank	Condition	Min	Тур	Max	Unit
A1	I <sub>F</sub> = 15 mA	45		60	
A2		60		80	
A3		80		100	mcd
A4		100		130	

 $\,$  Measurement Uncertainty of the Luminous Intensity :  $\pm\,$  10%

# Forward Voltage(V<sub>F</sub>) Ranks

				(Ta=25℃)
V <sub>F</sub> Rank	Condition	Min	Max	Unit
A		1.9	2.0	
В		2.0	2.1	
С		2.1	2.2	

\* Measurement Uncertainty of the Forward Voltage :  $\pm$  0.1V

# Color Wavelength (nm) Ranks

	<b>、</b> ,				(Ta=25℃
WD Rank	Condition	Min	Тур	Max	Unit
1	I <sub>F</sub> = 15 mA	586		588	
2		588		590	
3		590		592	nm
4		592		594	

\* Measurement Uncertainty of the Dominate Wavelength  $\pm 1 \text{ nm}$ 



LED

TOP VIEW YELLOW LED

2011/05-REV : 2.0

Part

## **12. REVISION HISTORY**

No	Date	Summary of Revision	Remarks
1	2003.05.	New establishment	
2	2004.11.	New Chromaticity Coordinates ranks	
3	2005.01.	Appliance Pb free material	
4	2006.05.	Document registration number change	
5	2007.10.	Revised All Sheets	
6	2011.05	Revised All Sheets	